



- NOTES:
1. GOLD PLATE 100u INCHES MIN OVER 80u INCHES MIN NICKEL.
  2. "G" PAD TO BE CONNECTED TO THE DIE ATTACH PAD.  
SEAL RING ISOLATED
  3. LEAD RESISTANCE: 300MQ MAX.
  4. SEAL RING AND DIE ATTACH PAD TO BE METALIZED

REV	DESCRIPTION	DATE
3		
2	LEAD ALLOY42	
1	CERAMIC BLACK ALUMINA	
NEW DRAWING APR.-07 -2003		
Drawn	Y. SUZUKI	NTK
Checked	J. WASHINO	NGK SPARK PLUG CO., LTD.
Approved	J. WASHINO	TITLE
CUSTOMER		28 LD FLAT PKG
DWG NO.		UNIT: MM INCH DWG: 1/8"
		SCALE: /
		IFK28F1-2113A

MODIFIED DWG NO.